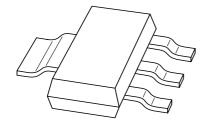
## **DISCRETE SEMICONDUCTORS**

## DATA SHEET



# **BAT120**Schottky barrier double diodes

Product specification Supersedes data of 1998 Oct 30 2001 Aug 27





## Schottky barrier double diodes

#### **BAT120**

#### **FEATURES**

- Low switching losses
- Capability of absorbing very high surge current
- · Fast recovery time
- · Guard ring protected
- · Plastic SMD package.

#### **APPLICATIONS**

- Low power switched-mode power supplies
- Rectification
- · Polarity protection.

#### **DESCRIPTION**

Planar Schottky barrier double diodes encapsulated in a SOT223 plastic SMD package

#### **MARKING**

TYPE NUMBER	MARKING CODE
BAT120A	AT120A
BAT120C	AT120C
BAT120S	AT120S

#### **PINNING**

DIN	BAT120						
PIN	Α	С	S				
1	k <sub>1</sub>	a <sub>1</sub>	a <sub>1</sub>				
2	n.c.	n.c.	n.c.				
3	k <sub>2</sub>	a <sub>2</sub>	k <sub>2</sub>				
4	a <sub>1</sub> , a <sub>2</sub>	k <sub>1</sub> , k <sub>2</sub>	k <sub>1</sub> , a <sub>2</sub>				

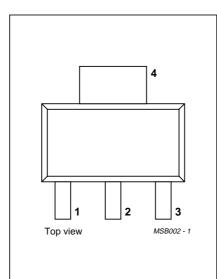


Fig.1 Simplified outline (SOT223) and pin configuration.

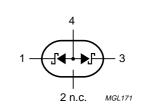
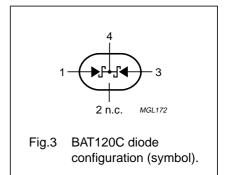


Fig.2 BAT120A diode configuration (symbol).



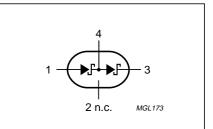


Fig.4 BAT120S diode configuration (symbol).

## Schottky barrier double diodes

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#### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per diode					
V <sub>R</sub>	continuous reverse voltage		_	25	V
I <sub>F</sub>	continuous forward current		_	1	А
I <sub>FSM</sub>	non-repetitive peak forward current	t <sub>p</sub> < 10 ms; half sinewave; JEDEC method	_	10	А
I <sub>RSM</sub>	non-repetitive peak reverse current	t <sub>p</sub> = 100 μs	_	0.5	А
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		_	125	°C
T <sub>amb</sub>	operating ambient temperature		-65	+125	°C

#### **ELECTRICAL CHARACTERISTICS**

 $T_{amb}$  = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
Per diode			•	•	•
V <sub>F</sub>	forward voltage	see Fig.5			
		I <sub>F</sub> = 100 mA	260	300	mV
		I <sub>F</sub> = 1 A	400	450	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 20 V; note 1; see Fig.6	80	500	μΑ
		V <sub>R</sub> = 25 V; note 1; see Fig.6	_	1	mA
		V <sub>R</sub> = 20 V; T <sub>j</sub> = 100 °C; note 1	_	10	mA
C <sub>d</sub>	diode capacitance	$f = 1 \text{ MHz}$ ; $V_R = 4 \text{ V}$ ; see Fig.7	100	_	pF

#### Note

1. Pulse test:  $t_p = 300 \ \mu s; \ \delta = 0.02.$ 

#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to ambient	note 1	100	K/W

#### Note

1. Refer to SOT223 standard mounting conditions.

## Schottky barrier double diodes

**BAT120** 

#### **GRAPHICAL DATA**

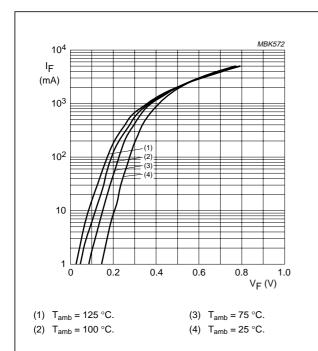


Fig.5 Forward current as a function of forward voltage; typical values.

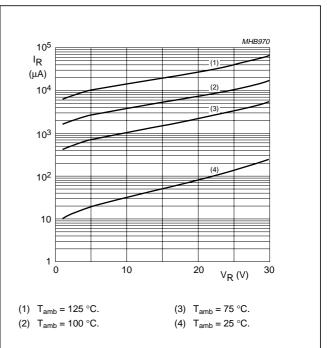
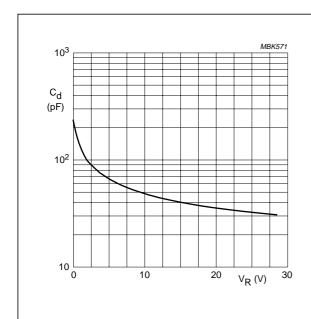


Fig.6 Reverse current as a function of reverse voltage; typical values.



f = 1 MHz;  $T_{amb}$  = 25 °C.

Fig.7 Diode capacitance as a function of reverse voltage; typical values.

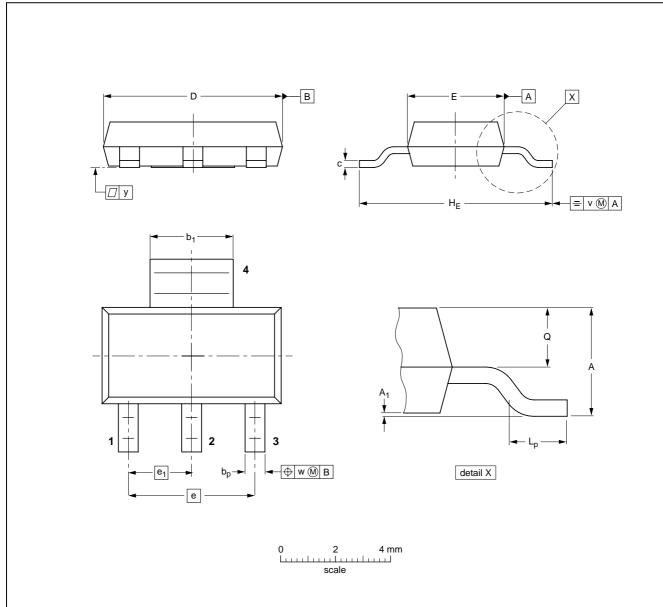
## Schottky barrier double diodes

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#### **PACKAGE OUTLINE**

Plastic surface mounted package; collector pad for good heat transfer; 4 leads

**SOT223** 



#### DIMENSIONS (mm are the original dimensions)

UNIT	A	A <sub>1</sub>	bp	b <sub>1</sub>	С	D	E	е	e <sub>1</sub>	HE	Lp	Q	v	w	у
mm	1.8 1.5	0.10 0.01	0.80 0.60	3.1 2.9	0.32 0.22		3.7 3.3	4.6	2.3	7.3 6.7	1.1 0.7	0.95 0.85	0.2	0.1	0.1

OUTI	INE		REFER	EUROPEAN	ISSUE DATE		
VERS	SION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT	223			SC-73			<del>97-02-28</del> 99-09-13

### Schottky barrier double diodes

**BAT120** 

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DATA SHEET STATUS(1)	PRODUCT STATUS <sup>(2)</sup>	DEFINITIONS
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## Schottky barrier double diodes

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